LM202802-L-C-300



PIN Diode Limiter
2 - 8 GHz
Rev. V1

Features

- Surface Mount Limiter in 8 mm x 5 mm x 2.5 mm Package
- Incorporates PIN Limiter Diodes, DC Blocks and DC Return
- Higher Peak Power Handling than Plastic: 100 W Peak Power
- Higher Average Power Handling than Plastic: 4 W CW Power
- Lower Insertion Loss: 1.1 dBLower Flat Leakage Power: 19 dB
- RoHS* Compliant

Description

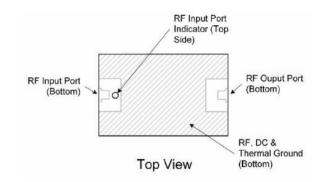
The LM202802-L-C-300 surface mount silicon PIN diode limiter is manufactured using a proven hybrid manufacturing process incorporating PIN diodes and passive devices integrated within a ceramic substrate. This low profile, compact, surface mount component offers superior low and high signal performance to comparable MMIC devices in QFN packages. The limiter modules are designed to optimize small signal insertion loss, noise figure and high signal flat leakage performance in a compact, surface mount package from 2 - 8 GHz.

Using PIN diodes with lower thermal resistance (<100°C/W), RF CW incident power levels of +36 dBm and RF peak incident power levels of +50 dBm @ 1 μ s RF pulse width, 0.1% duty cycle are very achievable. In addition, this design concept provides lower flat leakage power (<+19 dBm) and lower spike leakage energy (<0.2 Ergs) for superior LNA protection.

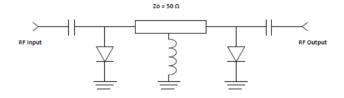
These LM202802-L-C-300 limiters are ideal for octave band radar applications, requiring high volume, surface mount, solder re-flow manufacturing. These products are durable, reliable, and capable of meeting all military, commercial, and industrial environments. The devices are fully RoHS compliant and are available in tube or tape-reel.



Pin Out



Limiter Schematic



Ordering Information

Part Number	Package		
LM202802-L-C-300-T	tube packaging		
LM202802-L-C-300-R	250 or 500 piece reel		
LM202802-L-C-300-W	waffle packaging		
LM202802-L-C-300-E	RF evaluation board		

^{*} Restrictions on Hazardous Substances, European Union Directive 2011/65/EU.

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Electrical Specifications: Freq. = 2 - 8 GHz, T_A = +25°C, Z_0 = 50 Ω

Parameter	Test Conditions	Units	Min.	Тур.	Max.
Insertion Loss	Swept Frequency, P _{OUT} = 0 dBm	dB		-1.1	-1.4
Return Loss	Swept Frequency, P _{OUT} = 0 dBm	dB	-13	-15	_
Input 1 dB Compression Point	Swept Frequency	dBm	7	8	10
2ND Harmonic	$P_{OUT} = 0 \text{ dBm}$ $F_0 = 2 \text{ GHz}$	dBc	45	50	_
Peak Incident Power	RF Pulse Width = 1 μs, duty cycle = 0.1%	dBm		50	50
CW Incident Power	Swept Frequency	dBm	_	36	37
Flat Leakage Power	+47 dBm, RF pulse width = 1 µs, duty cycle = 0.1%	dBm	_	19	21
Spike Leakage Energy	+47 dBm, RF pulse width = 1 µs, duty cycle = 0.1%	erg		0.2	0.3
Recovery Time	50% falling edge of RF pulse to 1 dB IL, +47 dBm peak, RF pulse width = 1 µs, duty cycle = 0.1%	μs	_	75	150

Absolute Maximum Ratings^{1,2}

Parameter	Absolute Maximum		
RF CW Incident Power @ +85°C, Source & Load VSWR <1.2:1	36 dBm		
RF Peak Incident Power @ +85°C, Source & Load VSWR <1.2:1 RF Pulse Width = 1 µs, 0.1% Duty Cycle	50 dBm		
Insertion Loss Rate of Change with Operating Temperature	-0.003 dB / °C		
Thermal Resistance Junction to bottom surface of package	100°C/W		
Junction Temperature	+175°C		
Operating Temperature	-65°C to +125°C		
Storage Temperature	-65°C to +150°C		
Assembly Temperature	260°C for 10 seconds		

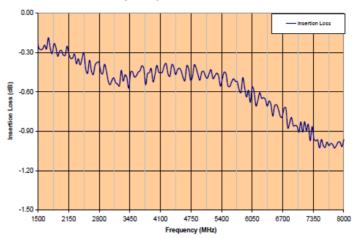
- 1. Exceeding any one or combination of these limits may cause permanent damage to this device.
- 2. MACOM does not recommend sustained operation near these survivability limits.
- 3. T_{C} is defined as the temperature of the bottom surface of the package.



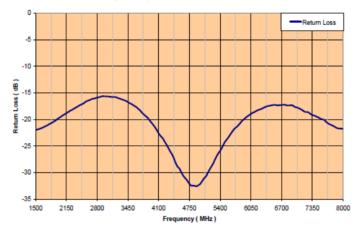
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Typical Performance Curves

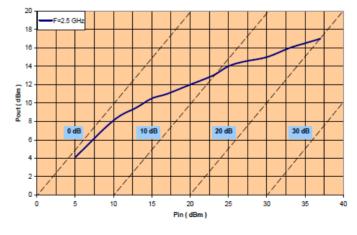
Insertion Loss vs. Frequency



Return Loss vs. Frequency



CW Output Power vs. CW Input Power



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Handling Procedures

Please observe the following precautions to avoid damage:

Static and Moisture Sensitivity

These electronic devices are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these Class 0 (HBM) devices.

The moisture sensitivity level rating for this device is MSL 2.

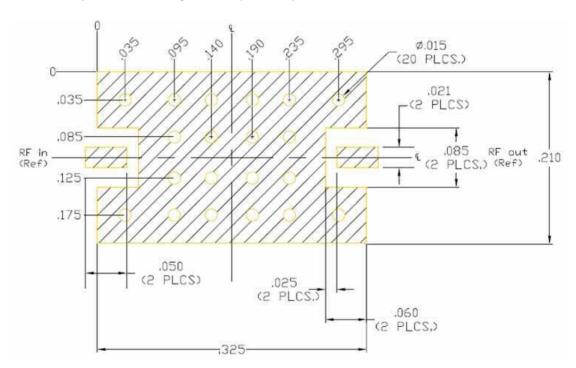
Environmental Capabilities

This limiter is capable of meeting the environmental requirements of MIL-STD-750 and MIL-STD-202.

Assembly Instructions

LM202802-L-C-300 may be placed onto circuit boards with pick and place manufacturing equipment from tube or tape-reel dispensing. The devices are attached to the circuit board using conventional solder re-flow or wave soldering procedures with RoHS type or Sn63/Pb37 type solders per Table 1 and Graph 1 Time-Temperature recommended profile.

RF Circuit Solder Footprint, case style 300 (CS300)



Recommended RF circuit is Rogers R04350B, 10 mils thick.

The hatched metal area on circuit side of device is RF, DC and thermal grounded. Vias should be solid copper fill and gold plated for optimum heat transfer from backside of switch module through circuit vias to metal thermal ground.

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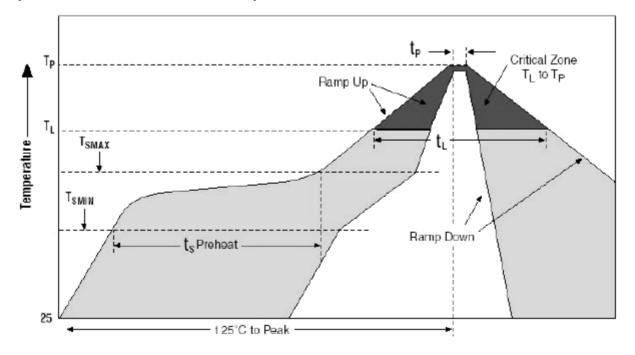


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Table 1: Time-Temperature Profile for Sn 60 / Pb 40 or RoHS Type Solders

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly	
Average ramp-up rate (TL to TP)	3°C/second maximum 3°C/second maximum		
Preheat - Temperature Minimum (TSMIN) - Temperature Maximum (TSMAX) - Time (Minimum to maximum) (ts)	100°C 150°C 60-120 seconds	150°C 200°C 60-180 seconds	
TSMAX to TL - Ramp-up Rate	_	3°C/second maximum	
Time Maintained above: - Temperature (TL) - Time (tL)	183°C 60-150 seconds	217°C 60-150 seconds	
Peak Temperature (TP)	225 +0 / -5°C	245 +0 / -5°C	
Time within 5°C of actual Peak Temperature (TP)	10-30 seconds	20-40 seconds	
Ramp-down Rate	6°C/second maximum 6°C/second maximum		
Time 25°C to Peak Temperature	6 minutes maximum 8 minutes maximum		

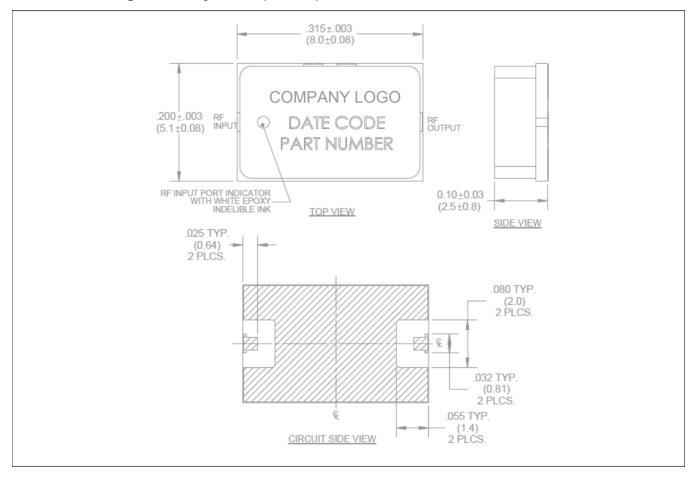
Graph1: Solder Re-Flow Time-Temperature Function





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Outline Drawing, Case Style 300 (CS300)



The hatched metal area on circuit side of device is RF, DC and thermal grounded.

Dimensions are in inches (mm)

Substrate Material: 20 mil thick Alumina Nitride (ALN)

RF Cover: Black Ceramic

Top Side and Backside Metallization: 100 μ IN. typical plated over Ti-Pd.

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